



注記
NOTES

- 材質
MATERIAL
りん青銅 (板厚: 0.2)
PHOSPHOR BRONZE (THICKNESS : 0.2)
- メッキ仕様
TERMINAL PLATING
接点部 : 金メッキ 0.25 μm MIN.
CONTACT AREA : GOLD 0.25 μm MIN.
圧着部 : 錫メッキ 1.0 μm MIN.
CRIMP AREA : TIN 1.0 μm MIN.
下地メッキ : ニッケルメッキ 2 μm MIN.
UNDER PLATE : NICKEL 2 μm MIN.
- 適用電線 : UL 1007 , AWG #24~28
APPLICABLE WIRE RANGE : UL1007 , AWG #24~28
- 被覆外径 : φ1.6 MAX.
INSULATION EXTERNAL DIA : φ1.6 MAX.
- 適用ハウジング : 51233-**** , 51234-****
APPLICABLE HOUSING : 51233-**** , 51234-****

バラ状 LOOSE	56116-8328	56116-8***
連鎖状 CHAIN	56116-8228	
端子形状 TERMINAL CONFIGURATION	MATERIAL No.	MODEL NO.

RELEASED EC NO: J2005-2545 DRWN: YSUGIURA01 2005/03/04 CHKD: MTANAKA 2005/03/07 APPR: NUKITA 2005/03/15	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER	±0.2	DRAWN BY YSUGIURA	DATE 2005/03/01	TITLE COMPACT ROBOT CONN. (CRC) CRIMP PIN -LEAD FREE-			
	10 OVER 30 UNDER	±0.25	CHECKED BY MTANAKA	DATE 2005/03/01	MOLEX INCORPORATED DOCUMENT NO. SD-56116-004 SHEET NO. 1 OF 1			
	30 OVER	±0.3	APPROVED BY NUKITA	DATE 2005/03/01				
	ANGULAR	±3 °	MATERIAL NO. SEE CHART					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				